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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

MT3S16U

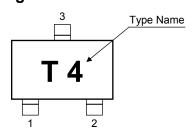
UHF Band Oscillator and Amplifier Applications

- fT is high and current dependability is excellent.
- The characteristic of Reverse transfer capacitance (Cre) is flat.

: NF = 2.4dB (typ.) (@ 2V, 5mA, 1 GHz)

 $: |S_{21e}|^2 = 4.5 dB \text{ (typ.) } (@ 2V, 10 mA, 1 GHz)$

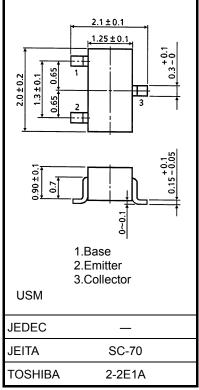
Marking



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	V _{CBO}	10	V	
Collector-emitter voltage	V _{CEO}	5	V	
Emitter-base voltage	V _{EBO}	2	V	
Collector current	IC	60	mA	
Base current	I _B	10	mA	
Collector power dissipation	PC	100	mW	
	P _C (Note.1)	180	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T _{stg}	-55 to 125	°C	

Unit: mm



Weight: 6 mg (Typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note.1: The device is mounted on a FR4 board (20mm X 25mm X 1.55 mm (t))

Start of commercial production 2002-09

Microwave Characteristics (Ta = 25°C)

Characteristics	Symbol	Condition	Min	Тур.	Max	Unit
Transition frequency	f _T	V _{CE} = 3 V, I _C = 10 mA	2	4	_	GHz
Insertion gain	$ S_{21e} ^2$ (1)	V _{CE} = 2 V, I _C = 10 mA, f = 1 GHz	_	4.5	_	- dB
	$ S_{21e} ^2$ (2)	V _{CE} = 3 V, I _C = 30 mA, f = 1 GHz	3	5.5	_	
Noise figure	NF	$V_{CE} = 2 \text{ V}, I_{C} = 5 \text{ mA}, f = 1 \text{GHz}$	_	2.4	3.2	dB

Electrical Characteristics (Ta = 25°C)

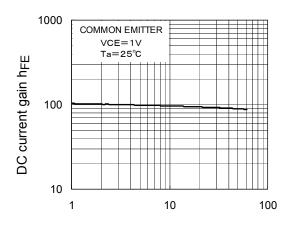
Characteristics	Symbol	Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	$V_{CB} = 5 \text{ V}, I_{E} = 0$	_	_	0.1	μА
Emitter cut-off current	I _{EBO}	$V_{EB} = 1 \text{ V, } I_{C} = 0$	_	_	1	μА
DC current gain	h _{FE}	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}$	80	_	140	
Reverse transfer capacitance	C _{re}	$V_{CB} = 1 \text{ V}, I_{E} = 0, f = 1 \text{ MHz (Note.2)}$		2.4	3	pF

Note.2: C_{re} is measured with a three-terminal method using a capacitance bridge.

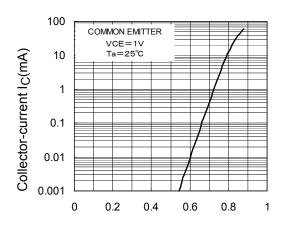
Caution

This device is sensitive to electrostatic discharge. Ensure that tools and equipment are sufficiently grounded before handling. When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

h_{FE}-l_C



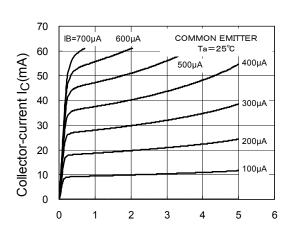
 I_{C} - V_{BE}



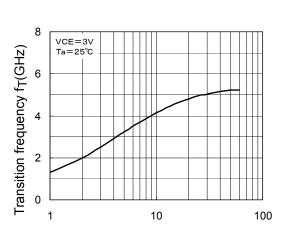
Collector-current I_C(mA)

Base-emitter voltage $V_{BE}(V)$

 I_{C} - V_{CE}



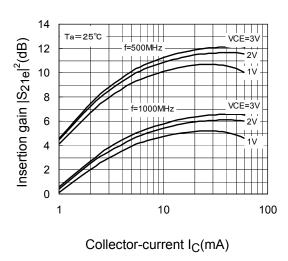
f_T-I_C



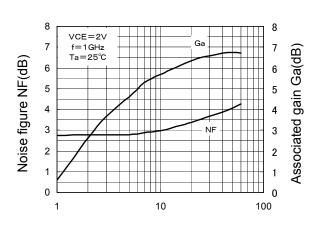
Collector-emitter voltage V_{CE}(V)

Collector-current I_C(mA)



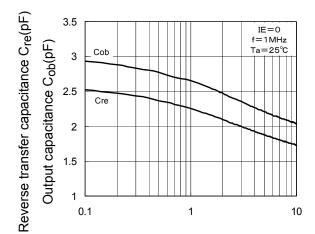


NF, Ga -I_C

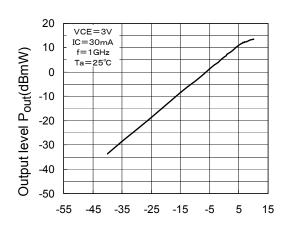


Collector-current I_C(mA)

 C_{re} , C_{ob} - V_{CB}



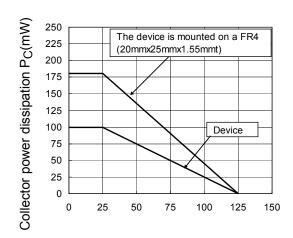
Pout - Pin



Collector-base voltage V_{CB}(V)

Input level Pin(dBmW)





Ambient temperature $T_a(^{\circ}C)$

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